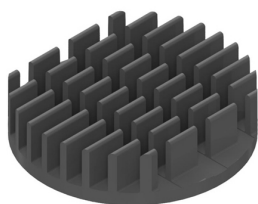


Data sheet Product ICK LED R 40 x 10 G



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 40 x 10 mm, for IC design LED

Features

diameter:	40 mm
way of fixation:	• therm. conductive foil • therm. cond. adhesive
height:	10 mm
plate thickness:	2.5 mm
thermal resistance:	12.66 - 2.5 K/W
dissipation loss:	9.3 W
surface:	black anodised

Technical Drawing

